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Augm

Computational Materials Science Laboratory

Dr. Raymundo Arroyave

Kubra Karayagiz, Luke Johnson, Thien Duong, Vahid Attari, Pejman Honarmandi, Tanner Kirk, Woongrak Son, Anjana Talapatra, Yuhao Wang

Materials Discovery: Efficient Global Optimization

XichLo - A Material Design Studio

kinetics of B2–L21 Ordering in Ni-Co-Mn-In





Identify the MAX phase with Maximum bulk modulus(K) Minimum shear modulus(G) Pareto front of materials with max K and min G

Generation Features used: Electronic structure properties Chemical composition Empirical model parameters

Single Objective : Maximize Bulk Modulus



Phase Field Modeling: Electronic Materials



Electrochemical response of microstructure @ 180°C

Design under Uncertainty Quantification





Thermo-Calc Optimized Phase Diagrams vs. MCMC Optimized Phase Diagram with Uncertainty Band





(Case 1 or Sn-retained microstructure) from left to right: a) Initial state, b) $4 \times 10^6 M_{m^2}$ after 125 107 Mm2 after 8 tom row (case 2 or Sn-exhausted microstructure) from left to right: e) Initial state, f) purs, g) $4 \times 10^7 \, M_m^2$ after 80 hours, h) $4 \times 10^8 \, M_m^2$ after 80 hours, i) $4 \times 10^9 \, M_m^2$ after 36 hours

Spinodal Decomposition in Pseudo-Ternary Nitrites TiAl(Cr)N and TiAl(Zr)N



A Path Planning Algorithm for Functionally Graded Materials Design

Functionally-Graded Material (FGM) Characterized by a variation in composition or structure gradually over volume







Multi-Scale Multi-Physics Modeling of Inconel 718 during Selective Laser Melting

Overview of the Developed Modeling Framework		
Thermal		Phase Field
Model		Model
MULTIPHYSICS	Thermal History	Interface



Nb Segregation Segregation pattern Segregation coefficien

<u>Growth Structure</u> Size and morphology

[2] Olzhas Adiyatov and Huseyin Atakan Varol. Rapidly-exploring random tree based memory efficient motion planning. In Mechatronics and Automation (ICMA), 2013 IEEE International Conference on, pages 354–359, 2013. DOI: <u>http://dx.doi.org/10.1109/ICMA.2013.6617944</u>

